

1A Low Dropout Positive Voltage Regulator

DESCRIPTION

TS1117B are high performance positive voltage regulators are designed for use in applications requiring low dropout performance at full rated current. Additionally; TS1117B provides excellent regulation over variations due to changes in line, load and temperature. Outstanding features include low dropout performance at rated current, fast transient response, internal current limiting and thermal shutdown protection of the output device. TS1117B are three terminal regulators with fixed and adjustable voltage options available in popular packages.

FEATURES

- Low Dropout Performance 1.5V max.
- Fast Transient Response
- Built-in thermal shutdown
- Output Current Limit
- Line Regulation Typical 0.2%
- Load Regulation Typical 0.05%
- Low-ESR Ceramic Capacitor (MLCC) required for Stability.
- Good Ripple Rejection
- Compliant to RoHS Directive 2011/65/EU and WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATION

- PC peripheral
- Communication
- Consumer equipment

Pin Definition:

Fixed / Adj
Output (Tab)
Input





Notes: MSL 3 (Moisture Sensitivity Level) per J-STD-020

TYPICAL APPLICATION CIRCUIT





Adjustable output voltage version

Fixed output voltage version



Taiwan Semiconductor

ABSOLUTE MAXIMUM RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Input Supply Voltage		V _{IN}	15	V
Recommend Operation Input Supply Voltage		V _{IN (Opr. Typ.)}	12	V
Power Dissipation (Note 2)		PD	Internal limited	
Operating Temperature Range		T _{OPER}	-40 ~ +125	°C
Junction Temperature Range		TJ	+150	°C
Storage Temperature Range		T _{STG}	-65 ~ +150	°C
TC			F	
	SOT-223		5	S

THERMAL PERFORMANCE				
DADAMETED	SYMBOL	LIMIT		
PARAMETER		SOT-223	TO-252	UNII
Junction to Ambient Thermal Resistance	R _{eja}	130	105	°C/W

Notes: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. $R_{\Theta JA}$ shown below for single device operation on FR-4 PCB in still air.

ELECTRICAL SPECIFICATIONS (T _A =25°C, unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	ТҮР	MAX	UNIT
Reference Voltage	V _{IN} = 2.75, I _O =1A	V _{REF}	1.225	1.25	1.275	V
	V _{IN} = 2.7V~12V, I _O =1A		1.176	1.2	1.224	
	V _{IN} = 3V~12V, I _O =1A		1.470	1.5	1.530	V
Output Voltage (Note 4)	V _{IN} = 4V~12V, I _O =1A	V _{OUT}	2.450	2.5	2.550	
	V _{IN} = 4.8V~12V, I _O =1A		3.235	3.3	3.366	
	V _{IN} = 6.5V~12V, I _O =1A		4.900	5.0	5.100	
Line Regulation	$V_0 + 1.5V \le V_{IN} \le 12V, I_0 = 10mA$	REG _{LINE}		0.2	0.5	%
Load Regulation (Note 1,2)	V _{IN} = V _{OUT} +1.5V, I _O = 10mA~1A	REGLOAD		0.05	1.0	%
Dropout Voltage	$I_0 = 1A$, $\Delta V_{OUT} = 1\% V_{OUT}$	V _{DROP}		1.3	1.5	V
Quiescent Current	V _{IN} = 5V	Ι _Q		5	10	mA
Adjustable Pin Current		I _{ADJ}	-	90		μA
Output Current Limit	$V_{IN} - V_{OUT} = 1.5V$	I _{LIMIT}	1.1			А
Temperature Stability	I ₀ =10mA,			0.5		%
Ripple Rejection	f= 120Hz, I ₀ = 1A, C _{OUT} =25µF, V _{IN} = V _{OUT} +3V	RR		60	70	dB

Note:

- 1. See thermal regulation specification for changes in output voltage due to heating effects. Line and load regulation are measured at a constant junction temperature by low duty cycle pulse testing. Load regulation is measured at the output lead = 1/18" from the package.
- 2. Line and load regulation are guaranteed up to the maximum power dissipation of 15W. Power dissipation is determined by the input / output voltage difference and the output current. Guaranteed maximum power dissipation will not be available over the full input / output voltage range.
- 3. Quiescent current is defined as the minimum output current required to maintain the regulation.
- The Output Capacitor does not have a theoretical upper limit and increasing its value will increase stability. C_{OUT}=100uF or more is typical for high current regulator design.



FUNCTION BLOCK



ORDERING INFORMATION

OUTPUT VOLTAGE	OUTPUT VOLTAGE PART NO.		PACKING	
	TS1117BCP ROG	TO-252 (DPAK)	2,500pcs / 13" Reel	
ADJ	TS1117BCW RPG	SOT-223	2,500pcs / 13" Reel	
1.2V	TS1117BCW12 RPG	SOT-223	2,500pcs / 13" Reel	
2.5V	TS1117BCW25 RPG	SOT-223	2,500pcs / 13" Reel	
2.01/	TS1117BCP33 ROG	TO-252 (DPAK)	2,500pcs / 13" Reel	
3.3V	TS1117BCW33 RPG	SOT-223	2,500pcs / 13" Reel	
5V	TS1117BCP50 ROG	TO-252 (DPAK)	2,500pcs / 13" Reel	
	TS1117BCW50 RPG	SOT-223	2,500pcs / 13" Reel	



CHARACTERISTICS CURVES



Figure 1. V_{DROP} vs. Output Current



Figure 3. Vout Change vs. Temperature



Figure 5. Line Transient Response



Figure 2. Load Regulation vs. Temperature



Figure 4. V_{OUT} Deviation vs. Temperature



Figure 6. Load Transient Response



PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)





SUGGESTED PAD LAYOUT

TAIWAN

IICONDUCTOR



MARKING DIAGRAM

5		
	в	
	TS111	7в
	YML	XX
	77 0	रु
ŧ	ıЦ	

- Y = Year Code
- **M** = Month Code for Halogen Free Product

O =Jan	P =Feb	Q =Mar	R =Apr
S =May	T =Jun	U =Jul	V =Aug
W =Sep	X =Oct	Y =Nov	Z =Dec

- L = Lot Code
- **XX** = Output Voltage Code (**3.3**=3.3V, **5.0**=5V)
 - = CP for Adjustable output voltage version



Taiwan Semiconductor



PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

SOT-223





SUGGESTED PAD LAYOUT (Unit: Millimeters)



MARKING DIAGRAM

5		
	TS111	7В
	YML	XX
¥1	ΗE	T T

- Y = Year Code
- **M** = Month Code for Halogen Free Product
 - O =Jan P =Feb Q =Mar R =Apr
 - S =May T =Jun U =Jul V =Aug W =Sep X =Oct Y =Nov Z =Dec
- L = Lot Code
- **XX** = Output Voltage Code (**1.2**=1.2V, **2.5**=2.5V, **3.3**=3.3V, **5.0**=5V)
 - = CW for Adjustable output voltage version